

27th RD50 workshop, CERN

IV-characterization of silicon sensors irradiated up to 2E16n_{eq}/cm²

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IV Measurement Aim

Current scaling:

$$\frac{I(T_2)}{I(T_1)} = \left(\frac{T_2}{T_1}\right)^2 exp\left(\frac{-E_{eff}}{2k_B} \frac{T_1 - T_2}{T_1 T_2}\right)$$

 E_{eff} : effective energy (1.214±0.014eV [1]); T_1 : measurement temperature, T_2 : scaling temperature; k_B : Boltzmann constant Use for scaling of current to different temperatures, determination of $E_{\rm eff}$ from measurement

Investigate behaviour of current for irradiated sensors

$$\frac{I(\Phi_{eq}) - I(\Phi_0)}{V} = \alpha \Phi_{eq}$$

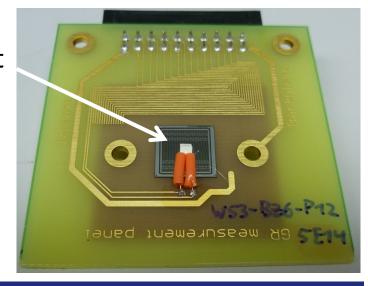
V: depleted volume; Φ_{eq} : equivalent fluence; $I(\Phi_0)$: nonirradiated current; α : current related damage rate Determination of α from measurements, α depends on the sensor annealing time

[1]: A. Chilingarov; Temperature dependence of the current generated in Si bulk; 2013_JINST_8_P10003



Sensors/Measurements

- Irradiate silicon sensors to different fluences
 - Protons (Birmingham):
 - ATLAS07 MINI (293 μ m): 1×10^{12} to 1×10^{15} n_{eq}/cm^2
 - Neutrons (Ljubljana):
 - ATLAS07 MINI (293 μ m): 5×10^{15} to 2×10^{16} n_{eq}/cm²
 - Micron 2437 (143 μ m): 5×10^{15} to 2×10^{16} n_{eq}/cm^2
 - Micron 2923 (108 μ m): 5×10^{15} to 2×10^{16} n_{eq}/cm²
 - Micron 2923 (108 μ m): 5×10^{15} to 2×10^{16} n_{eq} /cm² measured at CERN
 - Micron 3107 (50 μ m): 1×10¹⁵ to 2×10¹⁶ n_{eq}/cm²
- Glued PT1000 temperature sensor on sensor
- Perform IV/CV measurements in a freezer at different temperatures from -23°C to -15°C (at least 2 per sensor)
- Room temperature annealing in nitrogen cabinet to total annealing times of 10d and 30d





Old Liverpool Setup

Fan for air flow

PCB just placed in freezer
Fan for air circulation
Limited by freezer:
If freezer is constantly running a
temperature of -23°C can be reached
For higher temperatures a oscillation
can be observed due to the freezer not
being constantly on

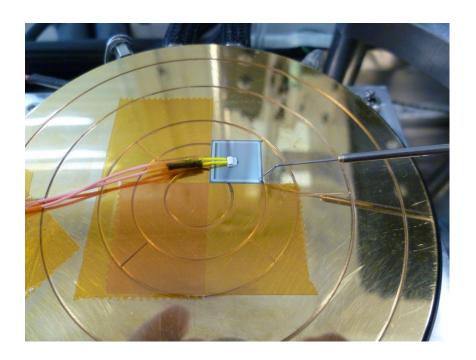
HV and PT1000 read out

PCB is floating to get maximal convective cooling



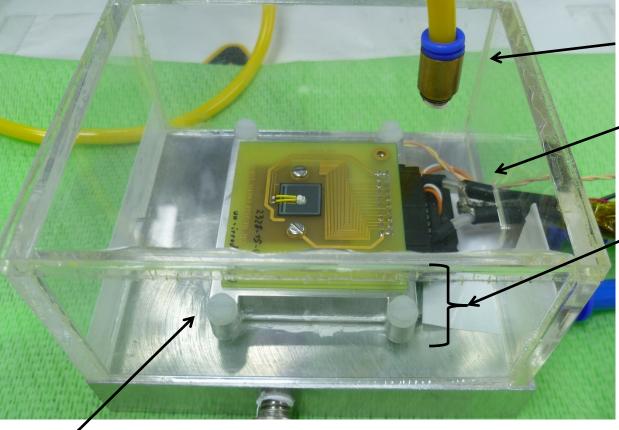
CERN setup

- Cold chuck, cooled by chiller and peltier
- PT1000 glued onto sensor for temperature measurement





New Liverpool setup



Perspex cover with Nitrogen inlet

HV and PT1000 connector

PCB

Mounting Plate

Peltier

Chuck cooled to chiller

Use Nylon screws to prevent heat loop

Sufficient flow of dry air / nitrogen is very important to prevent ice on sensor



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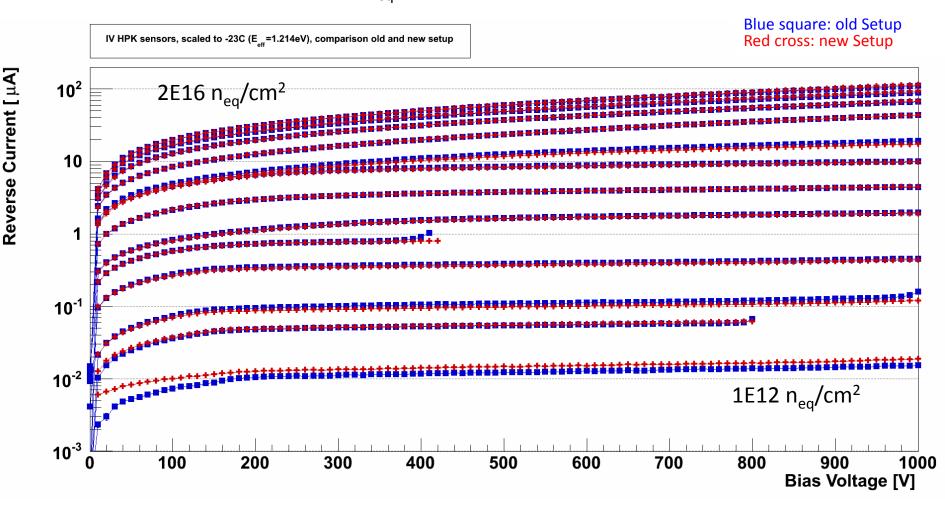
Measurements with new setup

- Same method used in Freiburg
 - Start at highest voltage and ramp down
 - Measurements at -25°C and -20°C (PT1000 at chuck)
 - Setup not in freezer
 - Chiller set to +5°C to prevent ice at tubes; Peltier power set to 15V (3A)
 - At -25°C use 90% of Peltier power
 - Peltier can cope with higher voltage (up to 29.8V, 6A), but this require a modification of the PID controller
- Cooling with new setup much faster
- PID parameters not optimal, but for first measurements they are acceptable



Comparison of Current

 $293\mu m \text{ sensors (HPK)}, 1E12 -> 2E16 n_{eq}/cm^2$





PT1000

$$R_t = R_0[1 + AT + BT^2 + C(T - 100^{\circ}C)T^3]$$

- *T*: temperature
- $R_0 = 1000\Omega$
- $A = 3.9083 \cdot 10^{-3} \, ^{\circ}\text{C}^{-1}$
- $B = -5.775 \cdot 10^{-7} \, ^{\circ}\text{C}^{-2}$

•
$$C = \begin{cases} -4.183 \cdot 10^{-12} \, ^{\circ}\text{C}^{-4} & -200 \, ^{\circ}\text{C} \le T \le 0 \, ^{\circ}\text{C} \\ 0 & 0 \, ^{\circ}\text{C} \le T \le 850 \, ^{\circ}\text{C} \end{cases}$$

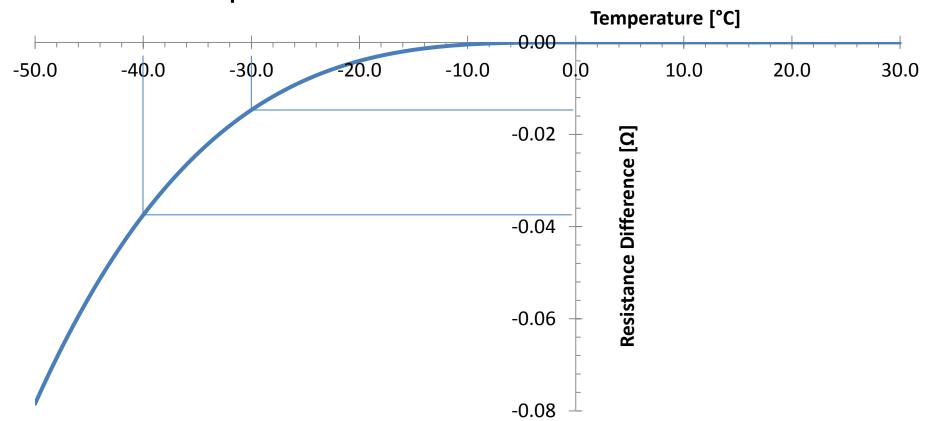
For temperatures < 0°C there is no analytical solution for this equation

- Possible to use a numerical method: calculate resistance for small temperature steps and compare with measured resistance. If values agree within a certain margin, use this temperature
- Use same format as for temperatures > 0°C (up to quadratic term),
 but there is a small deviation



PT1000

PT1000 difference quadratic to total



Temperature difference between full equation and "quadratic" approximation Up to -40°C the difference is less than 0.04Ω

- Measurement by hand: $\sigma_R = 0.1\Omega$
- Automatic measurement: $\sigma_R \le 0.02\Omega$



E_{eff} and α determination

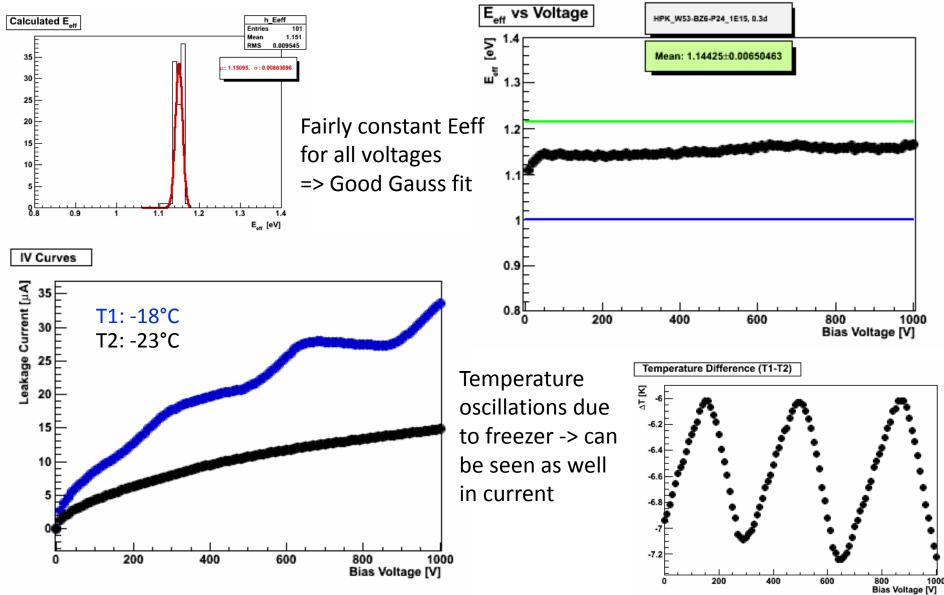


E_{eff} determination

- Calculate E_{eff} for IV measurements
 - E_{eff} value for each measured voltage
 - Fill data in Histogram
 - Fit with Gauss function
 - Calculate average value
- Fit E_{eff} vs Fluence with straight lines
 - Low energy (no slope): f(x) = a
 - High energy: $f(x) = a b \log_{10}(x)$

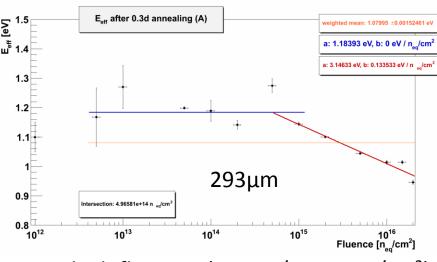


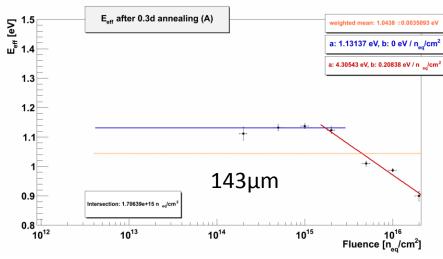
$293\mu m$, $1E15n_{eq}/cm^2$, 0.3d



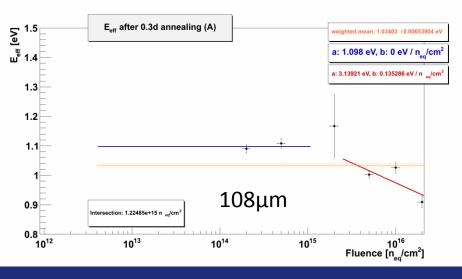


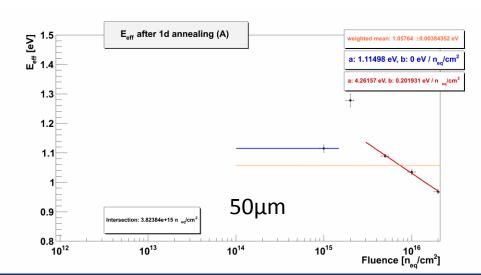
E_{eff} for different thickness





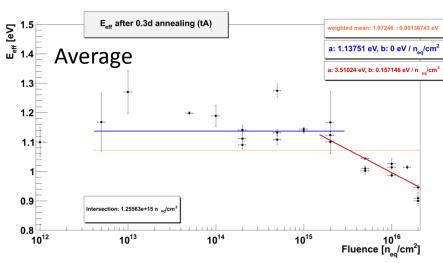
For high fluences (>1E15 / 2E15 n_{eq} /cm²) E_{eff} decreases with increasing fluence

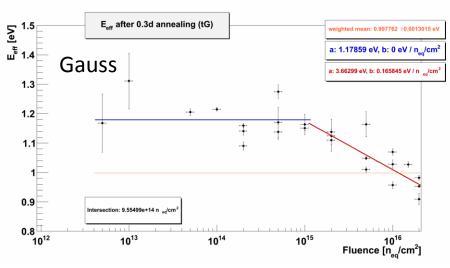






Gauss vs Average



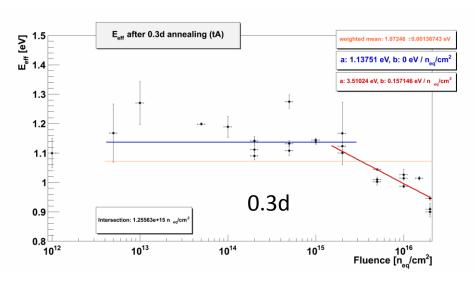


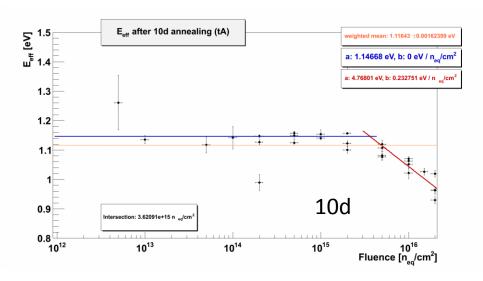
- Small difference between gauss and average $\mathsf{E}_{\mathsf{eff}}$ determination
 - Fit of gauss distribution not always possible

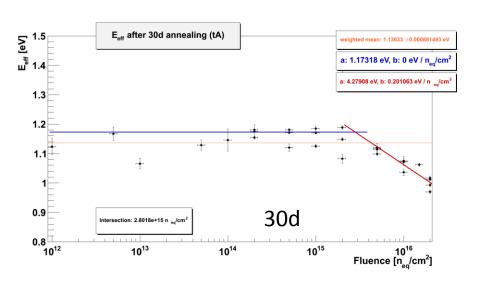
		а	$\sigma_{\rm a}$	b	$\sigma_{ m b}$
Low fluence	Average	1.138	0.002		
	Gauss	1.179	0.003		
High fluence	Average	3.51	0.16	0.16	0.01
	Gauss	3.7	0.2	0.166	0.013



Average values after annealing



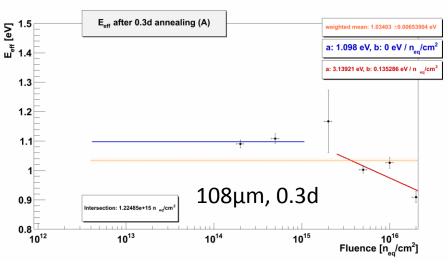


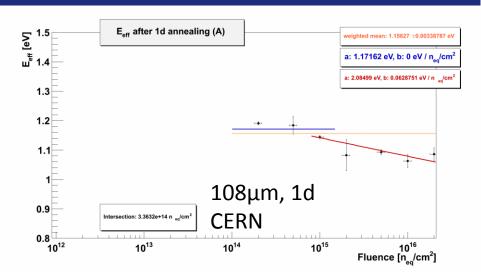


Small increase of E_{eff}
 values with increasing
 room temperature
 annealing time

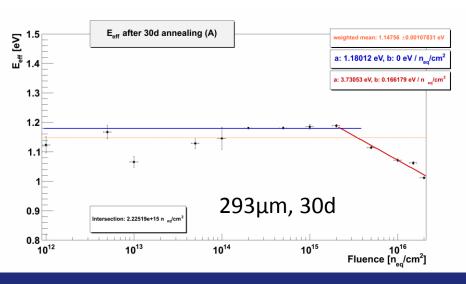


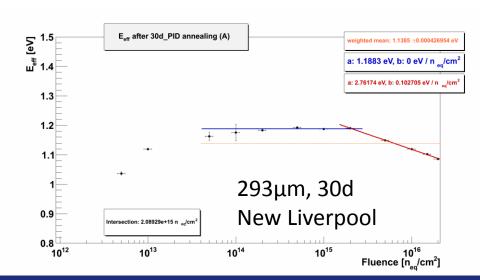
Compare freezer with cold chuck





Cold chuck method reduces E_{eff} decrease at high fluences a bit





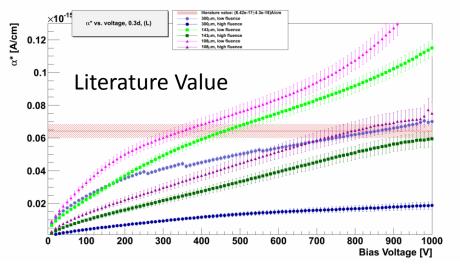


α determination

- Scale current to 21°C
 - Use different E_{eff} values
 - Literature value
 - For each sensor
 - Gauss value (from measurement of that sensor or from fit)
 - Average value (from measurement of that sensor or from fit)
 - Total Gauss / Average (fit using E_{eff} values from all sensors)
 - Fit straight line in $\Delta I/V$ vs Φ plot
 - low irradiation fluence (≤ 1E15n_{eg}/cm²)
 - high irradiation fluence (≥ 5E15 n_{eq}/cm²)
- But: sensors not fully depleted (particularly at high fluences)
 - Geometric current related damage rate α^* :
 - Instead of unknown depleted volume use the geometric volume
 - For fully depleted volume it is equal to the standard definition of α

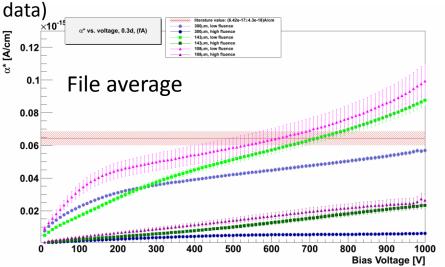


Which E_{eff} value to use

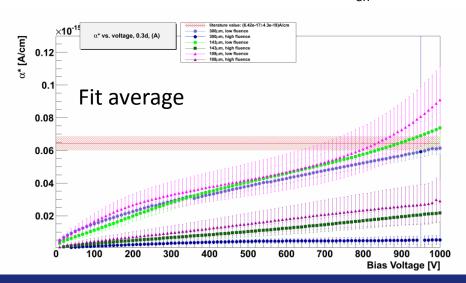


- Using literature value for scaling results in too high α^* values
- Using the determined values improves this
 - Using the fit data of all sensors the error bars increase due to the high spread of the values

Using separate E_{eff} values for each sensor (form IV

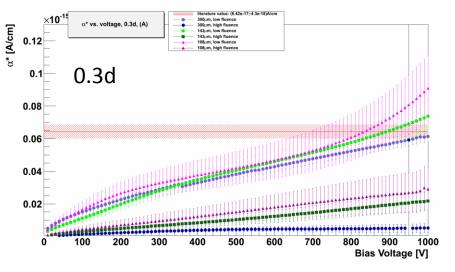


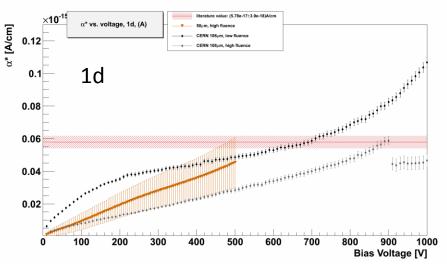
Using function from fit of all average E_{eff} values





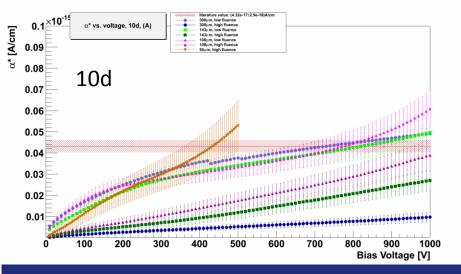
α^* after annealing

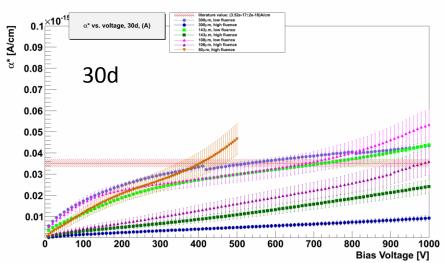




Large error bars due to large uncertainties for $E_{\rm eff}$ value from fit (high fluence scaled by factor 0.2 for better overview)

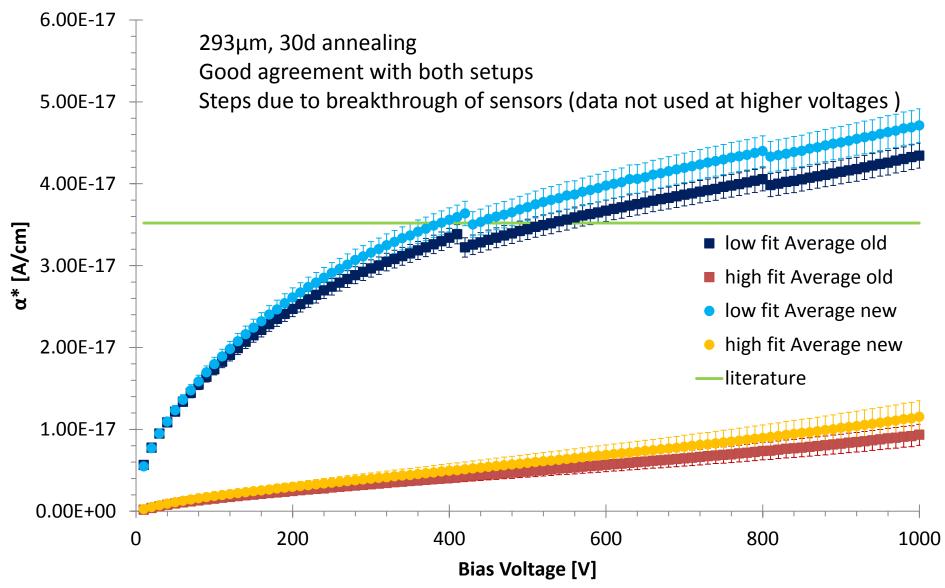
With increasing annealing time the high fluence values increase further towards literature value







Comparison freezer <-> cold chuck





Summary

- Computing $E_{\rm eff}$ from IV measurements it can be seen that at fluences > $2E15n_{\rm eq}/{\rm cm^2}$ the value decrease with increasing fluence
 - Same behaviour after room temperature annealing up to 30d
- Measurements with a cold chuck
 - Fast reach of target temperature
 - Can actively counter self heating
- For α^* determination the appropriate E_{eff} has to be used
 - For high fluences the literature value is not reached, but α^* is still increasing with increasing voltage => sensor not fully depleted



Backup



Alpha Literature I

Short term annealing

$$\alpha(t, T_a) = \alpha_{\infty} \sum_{i} \frac{b_i}{b_{\infty}} exp\left(-\frac{t}{\tau_i(T_a)}\right)$$

t: annealing time; T_a : annealing temperature

K
[2,3]
\checkmark

	i = 1	i = 2	<i>i</i> = 3	i = 4	<i>i</i> = 5	$i = \infty$
τ_i [min]	(1.78±0.10)×10 ¹	(1.19±0.03)×10 ²	(1.09±0.01)×10 ³	(1.48±0.01)×10 ⁴	(8.92±0.59)×10 ⁴	∞
b_i	0.156±0.038	0.116±0.003	0.131±0.002	0.201±0.002	0.093±0.007	0.303±0.006

$$\alpha_{\infty}$$
 = (2.86±0.18)×10⁻¹⁷ A/cm [4]

[2]: M. Moll; Radiation Damage in Silicon Particle Detectors; PHD Thesis

[3]: R. Wunstorf; Systematische Untersuchung zur Strahlenresistenz von Silizium-Detektoren für die Verwendung in Hochenergiephysik-Experimenten; **PHD Thesis**

[4]: A. Chilingarov; Radiation studies and operational projections for silicon in the ATLAS inner detector; NIM A 360 (1995) 432-437



Alpha Literature II

Long term annealing

$$\alpha(t) = \alpha_I exp\left(-\frac{t}{\tau_I}\right) + \alpha_0 - \beta \ln\left(\frac{t}{t_0}\right)$$

t: annealing time

Parameter for annealing at 21°C from fit

$$\alpha_I = 1.23 \times 10^{-17} \text{ A/cm}, \qquad \alpha_0 = 7.07 \times 10^{-17} \text{ A/cm}$$

$$\tau_I$$
=1.4×10⁴ min, t_0 =1 min

$$\beta$$
=3.29×10⁻¹⁸ A/cm

 α_I and β vary slightly with annealing temperature, average values: $\langle \alpha_I \rangle = (1.23 \pm 0.06) \times 10^{-17} \text{ A/cm}, \langle \beta \rangle = (3.07 \pm 0.18) \times 10^{-18} \text{ A/cm}$ α_0 depend on annealing temperature => value from parameterization: $\alpha_0 = (6.74 \pm 0.06) \times 10^{-17} \text{ A/cm}$

[2]: M. Moll; Radiation Damage in Silicon Particle Detectors; PHD Thesis



Alpha Values Literature

- Using equations to calculate theoretical alpha values
- Annealing temperature of 20°C (room temperature)
- Sample preparation: \sim 470min (0.3d) for all sensors
- Room temperature annealing of sensors in Nitrogen box

Annealing time	Short term annealing	Long term annealing	Long term annealing (average)
t [min]		α [10 ⁻¹⁷ A/cm]	
0.3d (=470 min)	6.40±0.43	6.24	6.04±0.14
10d (=14400min)	4.32±0.29	4.36	4.24±0.18
30d (=43220min)	3.50±0.23	3.61	3.52±0.20



bold: "theoretical value" for comparison



α determination

$$\begin{split} \sigma_{I(T_2)}^2 &= I(T_2)^2 \left[\left(\frac{\sigma_{I(T_1)}}{I(T_1)} \right)^2 + \left(2 + \frac{E_{eff}}{2k_B T_1} \right)^2 \left(\frac{\sigma_{T_1}}{T_1} \right)^2 \right. \\ &+ \left(2 + \frac{E_{eff}}{2k_B T_2} \right)^2 \left(\frac{\sigma_{T_2}}{T_2} \right)^2 + \left(\frac{1}{2k_B} \left(\frac{1}{T_2} - \frac{1}{T_1} \right) \right)^2 \sigma_{E_{eff}}^2 \right] \end{split}$$

- Major source for uncertainty: E_{eff} fit for high fluences
 - $-\frac{\sigma_{E_{eff}}}{E_{eff}}$ is up to 10% for high fluences, which results in large uncertainties of the scaled current and therefore large uncertainties of the straight line fit
 - Had to scale $\sigma_{E_{eff}}$ down by factor 0.2 to get a reasonable size of the error bars in the graph

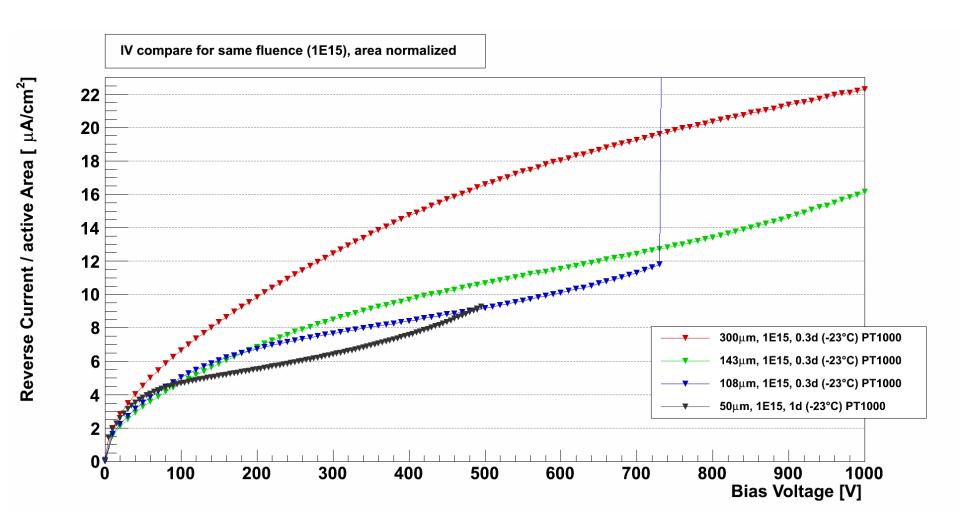


Leakage Current at different fluences

FOR SENSORS WITH DIFFERENT THICKNESS

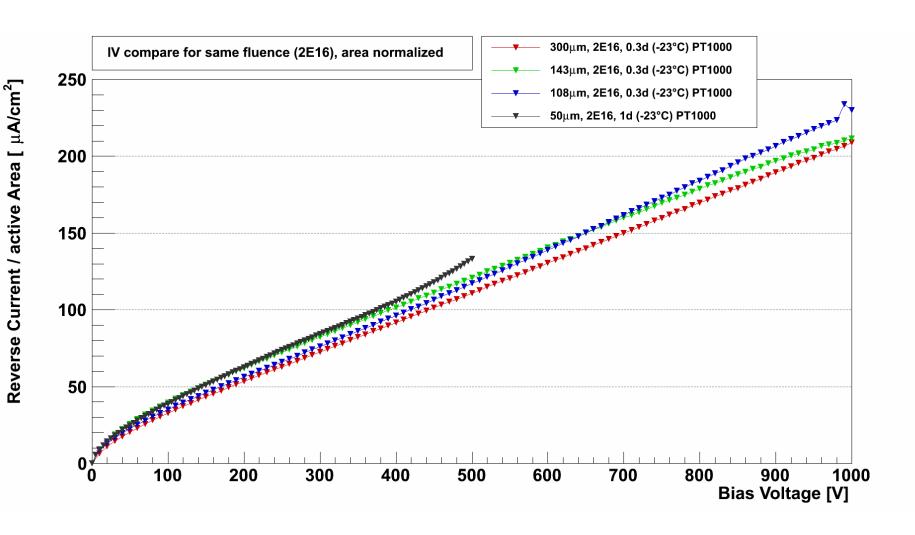


$0.3d, 1E15 n_{eq}/cm^2$





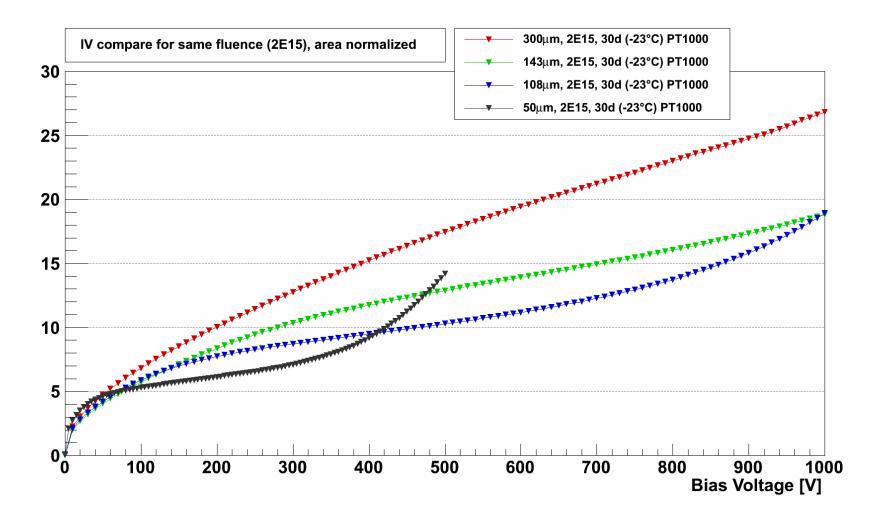
0.3d, 2E16 n_{eq} /cm²





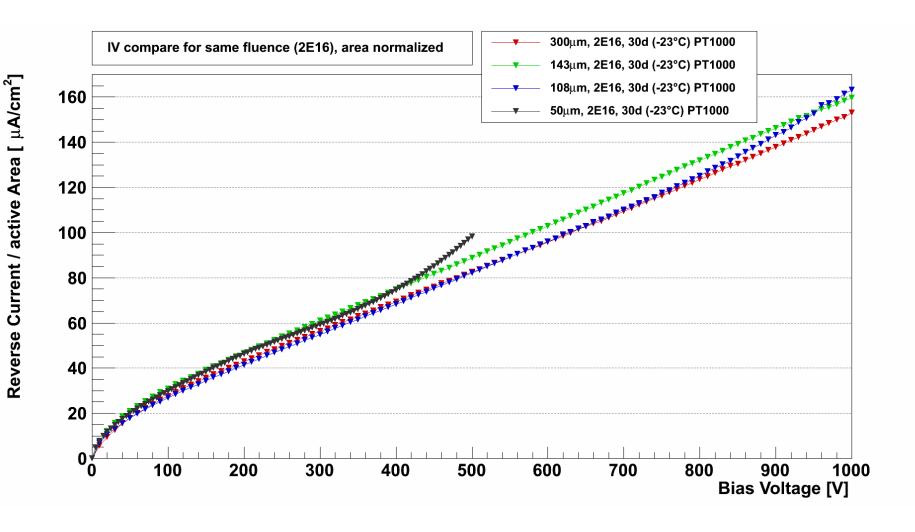
30d, 2E15 n_{eq}/cm²







30d, $2E16 n_{eq}/cm^2$



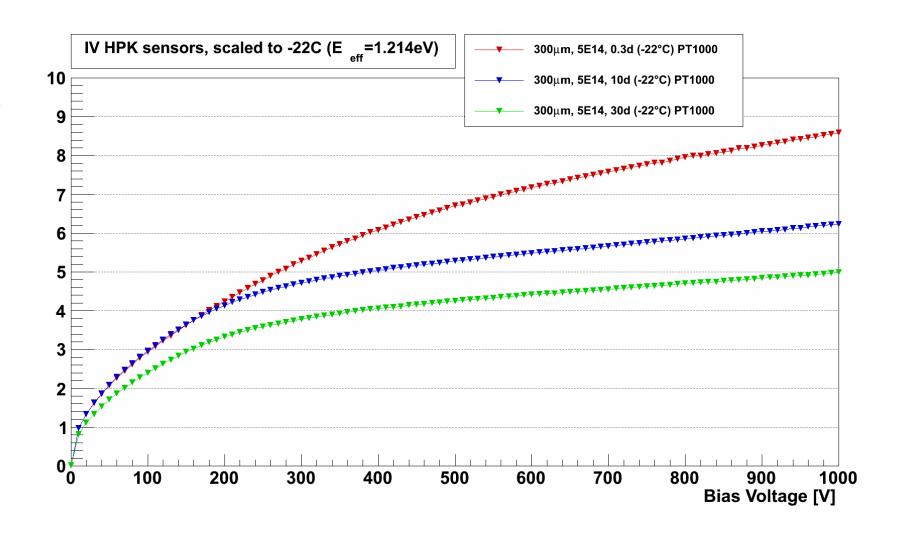


Leakage Current at different annealing steps

FOR SAME SENSOR



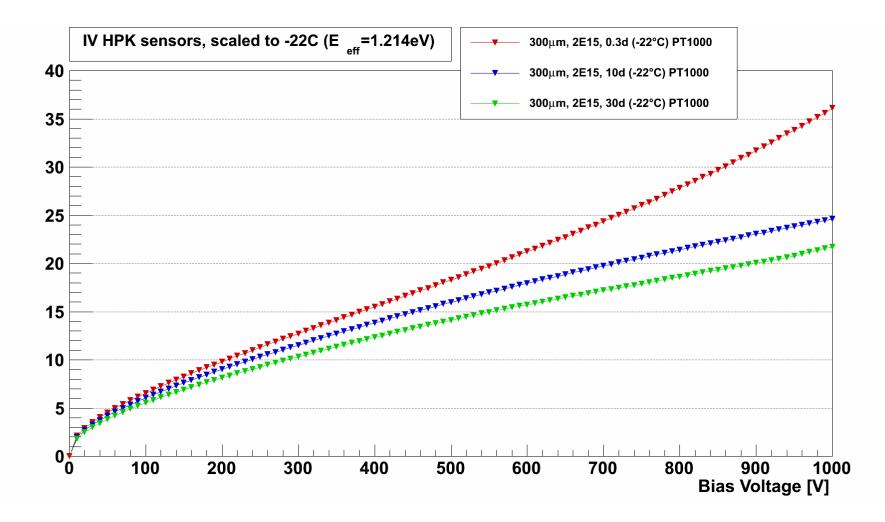
$5E14 n_{eq}/cm^2$





$2E15 n_{eq}/cm^2$







Simulations and Error reflection

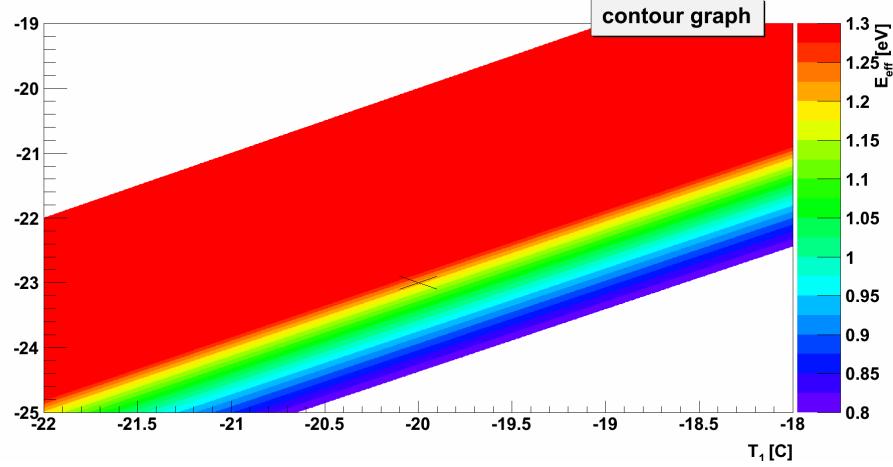
E_{eff} variation

- In formula two possible causes of variation in E_{eff}:
 - Wrong temperature measurement (not only temperature of sensor, also temperature of freezer => temperature measured too cold)
 - Wrong current measurement
- Simulation of influence from both effects on E_{eff} with:
 - Current measurement correct, only temperature variation
 - Temperature measurement correct, only current variation
- Chosen parameters:
 - $-T_1 = -20.0$ °C, $T_2 = -23.0$ °C
 - $-I_1 = 20.0\mu A$, $I_2 = 13.99\mu A$
 - Value of I₂ calculated from other parameters with E_{eff} = 1.214eV



Temperature Variation





Temperature measurement on the sensor could be affected by environment. The environment can be warmer than the sensor due to PID cooling, or the sensor can be warmer than the environment due to self heating. Either way the measured temperature is not the actual silicon temperature.